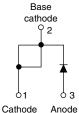


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Vishay Semiconductors

Fast Soft Recovery Rectifier Diode, 20 A



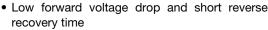


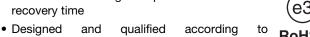
TO-220AC

0.00040	Cath

FEATURES

• 150 °C max operating junction temperature





• Compliant to RoHS Directive 2002/95/EC

• Halogen-free according to IEC 61249-2-21 definition (-M3 only)





HALOGEN

FREE

APPLICATIONS

JEDEC-JESD47

These devices are intended for use in output rectification and freewheeling in inverters, choppers and converters as well as in input rectification where severe restrictions on conducted EMI should be met.

DESCRIPTION

The VS-20ETF... fast soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

TO-220AC
20 A
800 V, 1000 V, 1200 V
1.31 V
355 A
95 ns
150 °C
Single die
0.6

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL CHARACTERISTICS VALUES UNITS						
V _{RRM}		800 to 1200	V			
I _{F(AV)}	Sinusoidal waveform	20	۸			
I _{FSM}		355	Α			
t _{rr}	1 A, 100 A/μs	95	ns			
V _F	20 A, T _J = 25 °C	1.31	V			
T _J	Range	- 40 to 150	°C			

VOLTAGE RATINGS							
PART NUMBER	I _{RRM} AT 150 °C mA						
VS-20ETF08PbF, VS-20ETF08-M3	800	900					
VS-20ETF10PbF, VS-20ETF10-M3	1000	1100	6				
VS-20ETF12PbF, VS-20ETF12-M3	1200	1300					

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum average forward current	I _{F(AV)}	T _C = 97 °C, 180° conduction half sine wave	20		
Maximum peak one cycle	ı	10 ms sine pulse, rated V _{RRM} applied	300	Α	
non-repetitive surge current	I _{FSM}	10 ms sine pulse, no voltage reapplied	355		
Maximum I ² t for fusing	l ² t	10 ms sine pulse, rated V _{RRM} applied	450	A ² s	
Maximum 1-t for fusing	1-1	10 ms sine pulse, no voltage reapplied	635	A-S	
Maximum I ² √t for fusing	I²√t	t = 0.1 ms to 10 ms, no voltage reapplied	6350	A²√s	



VS-20ETF..PbF Series, VS-20ETF..-M3 Series

ELECTRICAL SPECIFICATIONS							
PARAMETER SYMBOL TEST CONDITIONS VALUES UNIT							
Maximum forward voltage drop	V_{FM}	20 A, T _J = 25 °C		1.31	V		
Forward slope resistance	r _t	T _J = 150 °C		11.88	mΩ		
Threshold voltage	V _{F(TO)}			0.93	V		
Maximum rayarea laakaga current	1	T _J = 25 °C	V _B = Rated V _{BBM}	0.1	mA		
Maximum reverse leakage current	IRM	T _J = 150 °C	VR = nated VRRM	6	IIIA		

RECOVERY CHARACTERISTICS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Reverse recovery time	t _{rr}	I _F at 20 Apk	400	ns	I _{FM} +		
Reverse recovery current	I _{rr}	25 A/μs	6.1	Α	t _a t _b		
Reverse recovery charge	Q _{rr}	25 °C	1.7	μC	dir/ dt Q _{rr}		
Snap factor	S	Typical	0.6		I _{RM(REC)}		

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range	T _J , T _{Stg}		- 40 to 150	°C	
Maximum thermal resistance, junction to case	R_{thJC}	DC operation	0.9		
Maximum thermal resistance, junction to ambient	R _{thJA}		62	°C/W	
Typical thermal resistance, case to heatsink	R _{thCS}	Mounting surface, smooth and greased	0.5		
Approximate weight			2	g	
Approximate weight			0.07	OZ.	
Mounting torque			6 (5)	kgf ⋅ cm	
Mounting torque maximum			12 (10)	(lbf · in)	
Marking device		Case style TO-220AC	20E	TF08 TF10 TF12	





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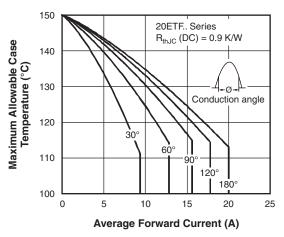


Fig. 1 - Current Rating Characteristics

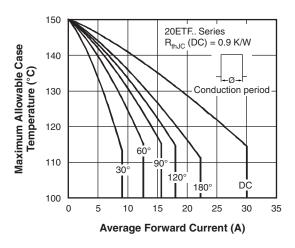


Fig. 2 - Current Rating Characteristics

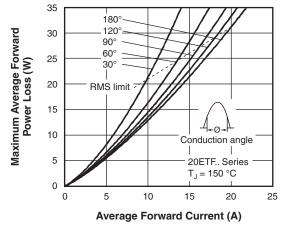


Fig. 3 - Forward Power Loss Characteristics

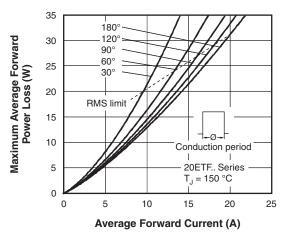


Fig. 4 - Forward Power Loss Characteristics

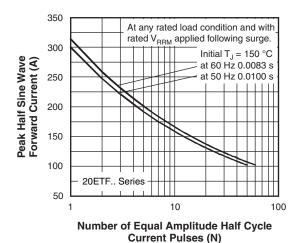


Fig. 5 - Maximum Non-Repetitive Surge Current

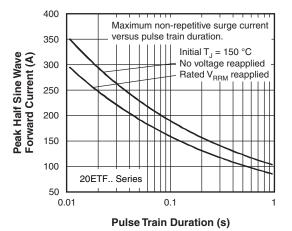


Fig. 6 - Maximum Non-Repetitive Surge Current





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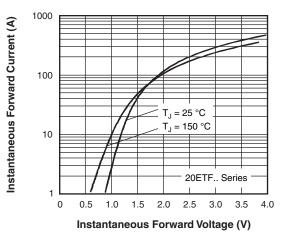


Fig. 7 - Forward Voltage Drop Characteristics

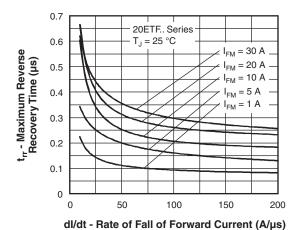


Fig. 8 - Recovery Time Characteristics, T_J = 25 °C

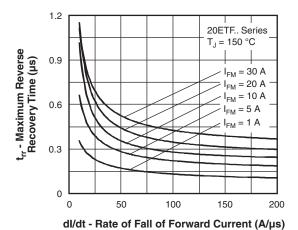


Fig. 9 - Recovery Time Characteristics, $T_J = 150 \, ^{\circ}\text{C}$

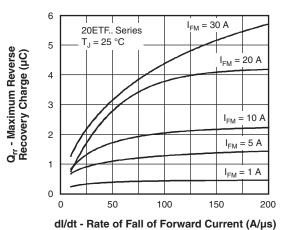


Fig. 10 - Recovery Charge Characteristics, T_J = 25 °C

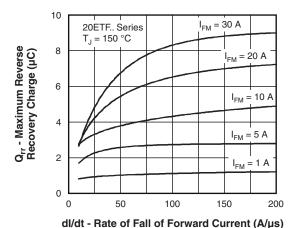
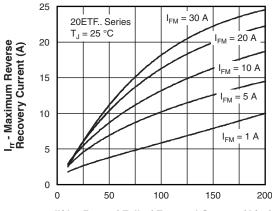


Fig. 11 - Recovery Charge Characteristics, T_J = 150 °C



dl/dt - Rate of Fall of Forward Current (A/µs)

Fig. 12 - Recovery Current Characteristics, $T_J = 25$ °C

VS-20ETF..PbF Series, VS-20ETF..-M3 Series

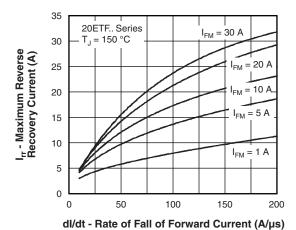


Fig. 13 - Recovery Current Characteristics, T_J = 150 °C

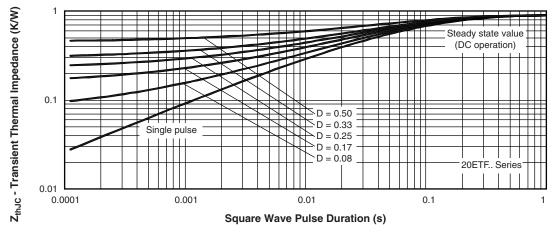


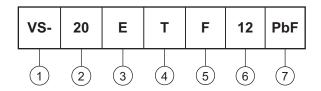
Fig. 14 - Thermal Impedance Z_{thJC} Characteristics

VS-20ETF..PbF Series, VS-20ETF..-M3 Series

Vishay Semiconductors

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (20 = 20 A)

3 - Circuit configuration:

E = Single diode

4 - Package:

_ __

T = TO-220AC

5 - Type of silicon:

F = Fast soft recovery rectifier

08 = 800 V

6 - Voltage ratings

10 = 1000 V 12 = 1200 V

7 - Environmental digit

...

• PbF = Lead (Pb)-free and RoHS compliant

• -M3 = Halogen-free, RoHS compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-20ETF08PbF	50	1000	Antistatic plastic tube				
VS-20ETF08-M3	50	1000	Antistatic plastic tube				
VS-20ETF10PbF	50	1000	Antistatic plastic tube				
VS-20ETF10-M3	50	1000	Antistatic plastic tube				
VS-20ETF12PbF	50	1000	Antistatic plastic tube				
VS-20ETF12-M3	50	1000	Antistatic plastic tube				

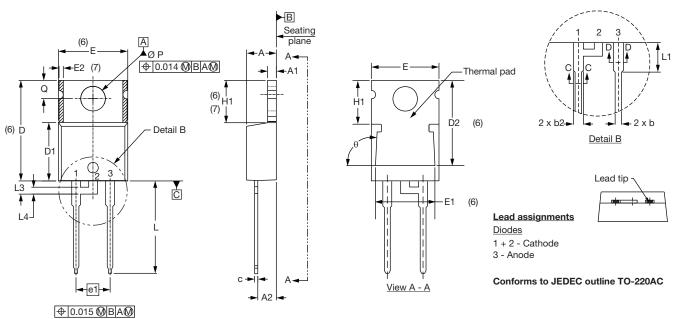
LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?95221</u>					
Dort marking information	TO-220AC PbF	www.vishay.com/doc?95224			
Part marking information	TO-220AC -M3	www.vishay.com/doc?95068			



Vishay Semiconductors

TO-220AC

DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	IETERS	INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.56	2.92	0.101	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
С	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.25	0.585	0.600	3
D1	8.38	9.02	0.330	0.355	
D2	11.68	12.88	0.460	0.507	6
Е	10.11	10.51	0.398	0.414	3, 6

SYMBOL	MILLIM	IETERS	INCHES		NOTES
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
E1	6.86	8.89	0.270	0.350	6
E2	-	0.76	-	0.030	7
е	2.41	2.67	0.095	0.105	
e1	4.88	5.28	0.192	0.208	
H1	6.09	6.48	0.240	0.255	6, 7
L	13.52	14.02	0.532	0.552	
L1	3.32	3.82	0.131	0.150	2
L3	1.78	2.13	0.070	0.084	
L4	0.76	1.27	0.030	0.050	2
ØΡ	3.54	3.73	0.139	0.147	
Q	2.60	3.00	0.102	0.118	
θ	90° t	o 93°	90° t	o 93°	

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimension E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, D2 (minimum) where dimensions are derived from the actual package outline



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Vishay

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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.